



CHENMKO ENTERPRISE CO.,LTD

SURFACE MOUNT

SCHOTTKY BARRIER DIODE

VOLTAGE 70 Volts CURRENT 15 mAmpere

Halogens free devices

CH157BGP

APPLICATION

- * For general purpose switching application

FEATURE

- * Small surface mounting type. (SOD-123)
- * Fast switch Time. (TRR=1.0nSec Typ.)
- * Low Forward Voltage Drop.
- * Lead free devices

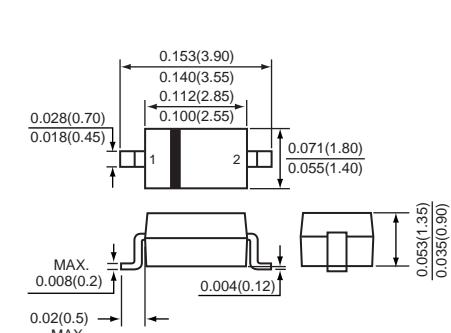
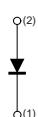
CONSTRUCTION

- * Silicon epitaxial planar

MARKING

- * BA1

CIRCUIT



Dimensions in inches and (millimeters)

SOD-123

MAXIMUM RATINGS (At TA = 25°C unless otherwise noted)

RATINGS	SYMBOL	CH157BGP	UNITS
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	70	Volts
Maximum RMS Voltage	V _{RMS}	49	Volts
Maximum DC Blocking Voltage	V _{DC}	70	Volts
Forward Continuous Current	I _O	15	mAmps
Non-Repetitive Peak Forward Surge Current @t=1.0uSec	I _{FSM}	2.0	Amps
Typical Junction Capacitance between Terminal (Note 1)	C _J	2.0	pF
Power Dissipation	P _d	330	mW
Thermal Resistance Junction to Ambient (Note 3)	R _{θJA}	300	°C/W
Maximum Operating Temperature Range	T _J	-65 to +125	°C
Maximum Storage Temperature Range	T _{STG}	-65 to +150	°C

ELECTRICAL CHARACTERISTICS (At TA = 25°C unless otherwise noted)

CHARACTERISTICS	SYMBOL	CH157BGP	UNITS
Reverse Breakdown Voltage at I _R =10uA	V _{BR}	70	Volts
Maximum Instantaneous Forward Voltage at I _F =15mA	V _F	1.0	Volts
Maximum Average Reverse Current at V _R =50V	I _R	200	nAmps
Maximum Reverse Recovery Time (Note 2)	T _{RR}	1.0	nSec

NOTES : 1. Measured at 1.0 MHz and applied reverse voltage of 0 volts.

2004-06

2. Measured at applied forward current of 5mA and reverse current of 5mA.

3. Device mounted on FR-4 by 1 inch X 0.85 inch X 0.062 inch

4. ESD sensitive product handling required.

RATING CHARACTERISTIC CURVES (CH157BGP)

FIG. 1 - TYPICAL POWER DERATING CURVE

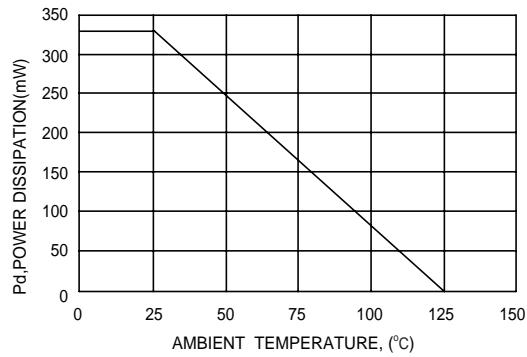


FIG. 2 - FORWARD CHARACTERISTICS

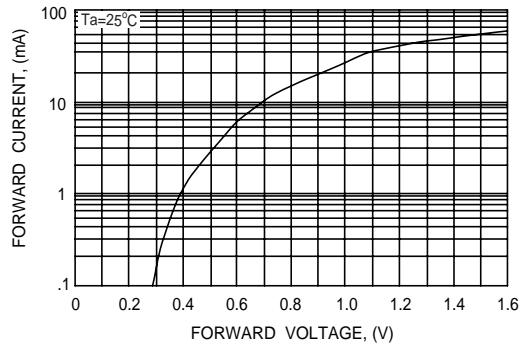


FIG. 3 - REVERSE CHARACTERISTICS

